

CALL FOR PARTICIPATION

COOL Chips is an International Symposium initiated in 1998 to present advancement of low-power and high-speed chips and systems. The symposium covers leading-edge technologies in all areas of microprocessors and their applications. The COOL Chips 24 is to be held in Tokyo on April 14-16, 2021, and is targeted at the architecture, design and implementation of chips with special emphasis on the areas listed below.

- **Low Power-High Performance Processors and Systems for AI, IoT, Multimedia, Digital Consumer Electronics, Mobile, Graphics, Encryption, Robotics, Automotive, Networking, Medical, Healthcare, and Biometrics.**
- **Novel Architectures and Schemes for Single Core, Multi-Core, Embedded Systems, Reconfigurable Computing, Grid, Ubiquitous, Dependable Computing, GALS and Wireless.**
- **Cool Software including - Parallel Schedulers, Embedded Real-time Operating System, Binary Translations, Compiler Issues and Low Power Application Techniques.**

Dates of Virtual Symposium

April 14 (Wed) – 16 (Fri), 2021

Keynote Presentations

- "虎穴に入らずんば虎子を得ず<High Risk, high return /No Risk, no return>: Domain-specific Processors make for Cool Solutions", *Avi Baum (Hailo)*
- "Why Preferred Networks Made MN-Core?", *Yusuke Doi (Preferred Networks)*
- "Codesign and System of the Supercomputer "Fugaku" ", *Mitsuhisa Sato (Riken)*
- "High-Efficiency Inferencing for Scalable Machine Learning", *Art Swift (Esperanto Technologies)*

Invited Presentations

- "Architectural Challenges in the Era of New Technologies and Extreme Heterogeneity", *Anastasiia Butko (Lawrence Berkeley Nat'l Lab.)*
- "The CMOS image sensor Advance in key technology and the Introduction of Next-generation image sensor", *Akito Kuwabara (Sony Semiconductor Solutions)*

Panel Discussion

- Topics: "'Hot' Techs for 'Cool' AI Computing: Do We have Enough Tricks?" (tentative),
Moderator: *Masato Motomura (Tokyo Tech)*

Special Session (invited lecture)

- "Reducing Errors in Quantum Computation via Program Transformation",
Moinuddin Qureshi (Georgia Institute of Technology)
- "Title: TBA", *Jakub Szefer (Yale University)*

(in alphabetical order)

For detailed and up-to-date information, please visit
< <https://www.coolchips.org/> >

Due to the uncertain situation with COVID-19, the organizing committee has decided to give up holding the conference normally at the original venue and have the COOL Chips 24 as in a web fashion. We appreciate your understanding and apologize to all of you for the inconvenience.

Symposium Registration

In order to make a registration, please visit COOL Chips 24 web site: < <https://www.coolchips.org/> >

== REGISTRATION FEES ==

Registration Fees include a copy of the proceedings (copies of speakers' slides) of all plenary and technical sessions and special sessions presented on April 14-16, 2021.

(including tax)	Early Registration by April 9, 2021	Late Registration from April 10, 2021
Member of any of IEEE, IEICE or IPSJ	30,000 yen	36,000 yen
Student (Member)	10,000 yen	12,000 yen
Life/Retired (Member)	10,000 yen	12,000 yen
Non-Member	40,000 yen	48,000 yen
Student (Non-Member)	14,000 yen	16,000 yen

== PAYMENT ==

Only credit cards via Whova Registration-site

Notes:

Credit card charges will be billed in Yen.

== ONLINE CHECK-IN ==

Check-in information will be provided severally by email from COOL Chips 24 no later than April 13.

== CONTACT to ==

Organizing Committee Secretaries
E-mail: cool_24@coolchips.org
<https://www.coolchips.org/>



Sponsored by the Technical Committees on
Microprocessors and Microcomputers and Computer
Architecture of the IEEE Computer Society.
In cooperation with the IEICE Electronics Society
and IPSJ.



(As of March 3, 2021)